

带有脉宽调制 **(PWM)** 接口和自动相移的用于笔记本电脑的白光发光二级管 **(WLED)** 驱动器

查询样品**: TPS61187**

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- **• PWM** 亮度界面控制
- **• PWM** 相移模式亮度调节方法或者直接 **PWM** 调光 方法
- **• 4kV** 人体模型 **(HBM)** 静电放电 **(ESD)** 保护
- **•** 可编程过压阀值
- **•** 内置 **WLED** 开路**/**短路保护
- **•** 热关断
- **• 20** 引脚 **4mm x 4mm x 0.8mm** 薄型四方扁平无引 线 **(TQFN)** 封装

应用范围

• 笔记本电脑 **LCD** 显示器背光源

特性 说明

4.5V 至 24V 输入电压 TPS61187 IC 为笔记本电脑 LCD 背光提供了一个高度 **• 38V** 最大输出电压 集成的 WLED 驱动器解决方案。 这个器件具有一个内 集成的 2A 40V 金属氧化物半导体场效应晶体管 置的高效升压稳压器, 此稳压器具有集成的 2.0A/40V (MOSFET) **the action of the contract of the c 300 kHz** 至 1 MHz 的可编程开关频率 **1000 年** 流调节和匹配。 该器件总共能够支持多达 60 个 自适应升压输出至 WLED 电压 WLED 2000 WLED。此外,升压输出还可自动地将其电压调节至 宽 PWM 调光频率范围 WELL TO THE DEST THE WARD THE DEST THE DEST THE DEST THE DEST THE DE

– 直接 **PWM** 模式下为 **100Hz** ^至 **50KHz** TPS61187 支持自动相移亮度调节方法和直接 PWM - 观率可编程模式下为 1**00Hz 至 22KHz**
20kHz 时的调光比为 100:1
中资东中检 、DMM 信号控制的上容比 k 波斯通货币 **• 20kHz** 时的调光比为 **100:1** 电流在由输入 PWM 信号控制的占空比上被接通/关闭 **• 200kHz** 时的调光比为 **1000:1**(直接 **PWM** 模式) 并且根据集成脉宽调制 (PWM) 信号确定的频率,每个 **•** 小型外部组件 通道被移位。 这个信号的频率可由电阻器进行编程, 果成坏路补偿
六个 30mA(最大值)电流吸入器 _{号直接控制} _{在直接 PWM} 查度调节期间 MLED 电 **•** 六个 **30mA** (最大值)电流吸入器 号直接控制。 在直接 PWM 亮度调节期间,WLED 电 **• 1.5%** 的电流匹配(典型值) 流被与输入 PWM 信号同步接通/关闭。

图 **1.** 典型应用**-**相移 **PWM** 模式

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TPS61187

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RUMENTS

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

PACKAGE INFORMATION(1)

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) (1)

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to network ground terminal.

RECOMMENDED OPERATING CONDITIONS

over ooperating free-air temperature range (unless otherwise noted)

(1) 5 µs min pulse on time.

THERMAL INFORMATION

(1) 有关传统和新的热度量的更多信息,请参阅 IC 封装热度量 应用报告 SPRA953。 **ELECTRICAL CHARACTERISTICS**

 $\rm{V_{IN}}$ = 12V, PWM/EN = high, IFB current = 20mA, IFB voltage = 500mV, T_A = –40°C to 85°C, typical values are at T_A = 25°C (unless otherwise noted)

ELECTRICAL CHARACTERISTICS (continued)

 $\rm V_{IN}$ = 12V, PWM/EN = high, IFB current = 20mA, IFB voltage = 500mV, T_A = –40°C to 85°C, typical values are at T_A = 25°C (unless otherwise noted)

DEVICE INFORMATION

PowerPAD information goes here.

PIN FUNCTIONS

(1) See Application Information section for details.

Texas **NSTRUMENTS**

TYPICAL CHARACTERISTICS

TABLE OF GRAPHS

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Figure 11. Phase Shift Waveform Figure 12. Phase Shift Waveform

Figure 13. Output Ripple Waveform Figure 14. Output Ripple Waveform

Figure 15. Start Up Waveform Figure 16. Start Up Waveform

FUNCTIONAL BLOCK DIAGRAM

DETAILED DESCRIPTION

NORMAL OPERATION

The TPS61187 is a high efficiency, high output voltage white LED driver for notebook panel backlighting applications. The advantages of white LEDs compared to CCFL backlights are higher power efficiency and lower profile design. Due to the large number of white LEDs required to provide backlighting for medium to large display panels, the LEDs must be arranged in parallel strings of several LEDs in series. Therefore, the backlight driver for battery powered systems is almost always a boost regulator with multiple current sink regulators. Having more white LEDs in series reduces the number of parallel strings and therefore improves overall current matching. However, the efficiency of the boost regulator declines due to the need for high output voltage. Also, there must be enough white LEDs in series to ensure the output voltage stays above the input voltage range.

The TPS61187 IC has integrated all of the key function blocks to power and control up to 60 white LEDs. The device includes a 40 V / 2 A boost regulator, six 30 mA current sink regulators, and a protection circuit for overcurrent, over-voltage, Open LED, Short LED, and output short circuit failures.

The TPS61187 integrates auto phase shifted PWM dimming methods with the PWM interface to reduce the output ripple voltage and audible noise. An optional direct PWM mode is user selectable through the MODE selection function.

SUPPLY VOLTAGE

The TPS61187 IC has a built-in linear regulator to supply the IC analog and logic circuit. The VDDIO pin, output of the regulator, is connected to a 1 µF bypass capacitor for the regulator to be controlled in a stable loop. VDDIO does not have high current sourcing capability for external use but it can be tied to the EN pin for start up.

BOOST REGULATOR AND PROGRAMMABLE SWITCH FREQUENCY (FSCLT)

The fixed-frequency PWM boost converter uses current-mode control and has integrated loop compensation. The internal compensation ensures stable output over the full input and output voltage ranges assuming the recommended inductance and output capacitance values shown in the Typical Application – Phase Shift PWM Mode figure are used. The output voltage of the boost regulator is automatically set by the IC to minimize voltage drop across the IFB pins. The IC regulates the lowest IFB pin to 350 mV, and consistently adjusts the boost output voltage to account for any changes in LED forward voltages. If the input voltage is higher than the sum of the white LED forward voltage drops (e.g., at low duty cycles), the boost converter is not able to regulate the output due to its minimum duty cycle limitation. In this case, increase the number of WLEDs in series or include series ballast resistors in order to provide enough headroom for the converter to boost the output voltage. Since the TPS61187 integrates a 2.0A/40V power MOSFET, the boost converter can provide up to a 38 V output voltage.

The TPS61187 switching frequency can be programmed between 300 kHz to 1.0MHz by the resistor value on the FSLCT pin according to Equation 1:

$$
F_{SW} = \frac{5 \times 10^{11}}{R_{FSLCT}}
$$

(1)

Where: R_{FSLCT} = FSCLT pin resistor

See Figure 7 for boost converter switching frequency adjustment resistor R_{FSLCT} selection.

The adjustable switching frequency feature provides the user with the flexibility of choosing a faster switching frequency, and therefore, an inductor with smaller inductance and footprint or slower switching frequency, and therefore, potentially higher efficiency due to lower switching losses. Use Equation 1 or refer to Table 1 to select the correct value:

LED CURRENT SINKS

The six current sink regulators embedded in the TPS61187 can be collectively configured to provide up to a maximum of 30 mA each. These six specialized current sinks are accurate to within ±2% max for currents at 20 mA, with a string-to-string difference of \pm 1.5% typical.

The IFB current must be programmed to the highest WLED current expected using the ISETH pin resistor and Equation 2.

$$
I_{FB} = \frac{V_{ISETH}}{R_{ISETH}} \times K_{ISET}
$$

(2)

Where:

 $K_{\text{ISET}} = 980$ (current multiple) V_{ISFTH} = 1.229V (ISETH pin voltage) $R_{\text{ISETH}} = \text{ISETH}$ pin resistor

ENABLE AND STARTUP

The internal regulator which provides VDDIO wakes up as soon as V_{IN} is applied even when EN is low. This allows the IC to start when EN is tied to the VDDIO pin. VDDIO does not come to full regulation until EN is high. The TPS61187 checks the status of all current feedback channels and shuts down any unused feedback channels. It is recommended to short the unused channels to ground for faster startup.

After the device is enabled, if the PWM pin is left floating, the output voltage of the TPS61187 regulates to the minimum output voltage. Once the IC detects a voltage on the PWM pin, the TPS61187 begins to regulate the IFB pin current, as pre-set per the ISETH pin resistor, according to the duty cycle of the signal on the PWM pin. The boost converter output voltage rises to the appropriate level to accommodate the sum of the white LED string with the highest forward voltage drops plus the headroom of the current sink at that current.

Pulling the EN pin low shuts down the IC, resulting in the IC consuming less than 11 µA in shutdown mode.

IFB PIN UNUSED

The TPS61187 has open/short string detection. For an unused IFB string, simply short it to ground or leave it open. Shorting unused IFB pins to ground for faster startup is recommended.

BRIGHTNESS DIMMING CONTROL

The TPS61187 has auto phase shifted PWM dimming control with the PWM control interface.

The internal decoder block detects duty information from the input PWM signal, saves it in an eight bit register and delivers it to the output PWM dimming control circuit. The output PWM dimming control circuit turns on/off six output current sinks at the PWM frequency set by RFPWM and the duty cycle from the decoder block.

The TPS61187 also has direct PWM dimming control with the PWM control interface. In direct PWM mode, each current sink turns on/off at the same frequency and duty cycle as the input PWM signal. See the Mode Selection section for dimming mode selection.

When in phase shifted PWM mode, it is recommended to insert a series resistor of 10kΩ to 20kΩ value close to PWMIN pin. This resistor together with an internal capacitor forms a low pass R-C filter with 30ns to 60ns time constant. This prevents possible high frequency noises being coupled into the input PWM signal and causing interference to the internal duty cycle decoding circuit. However, it is not necessary for direct PWM mode since the duty cycle decoding circuit is disabled during the direct PWM mode.

ADJUSTBLE PWM DIMMING FREQUENCY AND MODE SELECTION (R_FPWM / MODE)

The TPS61187 can operate in auto phase shift mode or direct PWM mode. Tying the RFPWM/MODE pin to VDDIO forces the IC to operate in direct PWM mode. A resistor between the RFPWM/MODE pin and ground sets the IC into auto phase shift mode and the value of the resistor determines the PWM dimming frequency. Use Equation 3 or refer to Table 2 to select the correct value:

$$
F_{\text{DIM}} = \frac{1.818 \times 10^8}{R_{\text{FPWM}}}
$$

(3)

Where: R_{FPWM} = RFPWM pin resistor

Table 2. R_{FPWM} Recommendations

MODE SELECTION – PHASE SHIFT PWM OR DIRECT PWM DIMMING

The phase shift PWM dimming method or direct PWM dimming method can be selected through the RFPWM pin. By attaching an external resistor to the RFPWM pin, the default phase shift PWM mode can be selected. To select direct PWM mode, the RFPWM pin needs to be tied to the VDDIO pin. The RFPWM/MODE pin can be noise sensitive when R2 has high impedance. In this case, careful layout or a parallel bypassing capacitor improves noise sensitivity but the value of the parallel capacitor may not exceed 33 pF for oscillator stability.

RFPWM

Selection

PHASE SHIFT PWM DIMMING

In phase shift PWM mode, all current feedback channels are turned on and off at F_{DIM} frequency with a constant delay. However, the number of used channels and PWM dimming frequency determine the delay time between two neighboring channels per Equation 4.

$$
T_{\text{delay}} = \frac{1}{n \times F_{\text{DIM}}}
$$

(4)

Where: n is the number of used channels

 F_{DIM} is the PWM dimming frequency which is determined by the value of R_{FPWM} on the RFPWM pin. Figure 19 provides the detailed timing diagram of the phase shift PWM dimming mode.

In phase shift PWM mode, the internal decoder converts the duty cycle information from the applied PWM signal at the PWM pin into an 8-bit digital signal and stores it into a register. The integrated dimming control circuit reconstructs the PWM duty cycle per the register value and sends it to each of the current sinks. In order to avoid any flickering while the duty cycle information is reconstructed from the register, one LSB (1/256) of duty cycle hysteresis is included which results in 1/256 resolution when incrementing the applied signal's duty cycle but 2/256 resolution when decrementing the duty cycle.

Figure 19. Phase Shift PWM Dimming Timing Diagram

EXAS

DIRECT PWM DIMMING

In direct PWM mode, all current feedback channels are turned on and off and are synchronized with the input PWM signal.

Figure 20. Direct PWM Dimming Timing Diagram

OVER VOLTAGE CLAMP / VOLTAGE FEEDBACK (OVC / FB)

The correct divider ratio is important for optimum operation of the TPS61187. Use the following guidelines to choose the divider value. It can be noise sensitive if R_{upper} and R_{down} have high impedance. Careful layout is required. Also, choose lower resistance values for R_{upper} and R_{down} when power dissipation allows.

Step1. Determine the maximum output voltage, V_O , for the system according to the number of series WLEDs.

Step2. Select an R_{upper} resistor value (1 MΩ for a typical application; a lower value such as 100 kΩ for a noisy environment).

Step3. Calculate R_{down} using Equation 5.

$$
V_{\text{OVP}} = \left(\frac{R_{\text{upper}}}{R_{\text{down}}} + 1\right) \times V_{\text{OV_TH}}
$$

(5)

Where: $V_{\text{OV_TH}} = 1.95 \text{ V}$

When the IC detects that the OVC pin exceeds 1.95 V typical, indicating that the output voltage is over the set threshold point, the OVC circuitry clamps the output voltage to the set threshold.

CURRENT SINK OPEN PROTECTION

For the TPS61187, if one of the WLED strings is open, the IC automatically detects and disables that string. The IC detects the open WLED string by sensing no current in the corresponding IFB pin. As a result, the IC deactivates the open IFB pin and removes it from the voltage feedback loop. Subsequently, the output voltage drops and is regulated to the minimum voltage required for the connected WLED strings. The IFB current of the connected WLED strings remains in regulation.

If any IFB pin voltage exceeds the IFB over-voltage threshold (13.5 V typical), the IC turns off the corresponding current sink and removes this IFB pin from the regulation loop. The current regulation of the remaining IFB pins is not affected. This condition often occurs when there are several shorted WLEDs in one string. WLED mismatch typically does not create large voltage differences among WLED strings.

The IC only shuts down if it detects that all of the WLED strings are open. If an open string is reconnected again, a power-on reset (POR) or EN pin toggling is required to reactivate a previously deactivated string.

OVER CURRENT AND SHORT CIRCUIT PROTECTION

The TPS61187 has a pulse-by-pulse over-current limit of 2.0 A (min). The PWM switch turns off when the inductor current reaches this current threshold. The PWM switch remains off until the beginning of the next switching cycle. This protects the IC and external components during on overload conditions. When there is a sustained over-current condition, the IC turns off and requires a POR or EN pin toggling to restart. Under severe over-load and/or short circuit conditions, the boost output voltage can be pulled below the required regulated voltage to keep all of the white LEDs operating. Under this condition, the current flows directly from input to output through the inductor and schottky diode. To protect the TPS61187, the device shuts down immediately. The IC restarts after input POR or EN pin toggling.

THERMAL PROTECTION

When the junction temperature of the TPS61187 is over 150°C, the thermal protection circuit is triggered and shuts down the device immediately. Only a POR or EN pin toggling clears the protection and restarts the device.

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APPLICATION INFORMATION

INDUCTOR SELECTION

Because selection of the inductor affects power supply steady state operation, transient behavior, and loop stability, the inductor is the most important component in switching power regulator design. There are three specifications most important to the performance of the inductor: inductor value, dc resistance, and saturation current. The TPS61187 is designed to work with inductor values between 10 µH and 47 µH. A 10 µH inductor is typically available in a smaller or lower profile package, while a 47 µH inductor may produce higher efficiency due to a slower switching frequency and/or lower inductor ripple. If the boost output current is limited by the overcurrent protection of the IC, using a 10 µH inductor and the highest switching frequency maximizes controller output current capability.

Internal loop compensation for PWM control is optimized for the external component values, including typical tolerances, recommended in Table 3. Inductor values can have $\pm 20\%$ tolerance with no current bias. When the inductor current approaches saturation level, its inductance can decrease 20% to 35% from the 0 A value depending on how the inductor vendor defines saturation. In a boost regulator, the inductor dc current can be calculated with Equation 6.

$$
I_{DC} = \frac{Vout \times lout}{Vin \times \eta}
$$

Where:

Vout = boost output voltage Iout = boost output current Vin = boost input voltage η = power conversion efficiency, use 90% for TPS61187 applications

The inductor current peak-to-peak ripple can be calculated with Equation 7.

$$
I_{PP} = \frac{1}{L \times \left(\frac{1}{Vout - Vin} + \frac{1}{Vin}\right) \times F_S}
$$

Where:

 I_{PP} = inductor peak-to-peak ripple $L =$ inductor value F_S = Switching frequency Vout = boost output voltage Vin = boost input voltage

Therefore, the peak current seen by the inductor is calculated with Equation 8.

$$
I_P = I_{DC} + \frac{I_{PP}}{2}
$$

Select an inductor with a saturation current over the calculated peak current. To calculate the worst case inductor peak current, use the minimum input voltage, maximum output voltage, and maximum load current.

Regulator efficiency is dependent on the resistance of its high current path and switching losses associated with the PWM switch and power diode. Although the TPS61187 IC has optimized the internal switch resistances, the overall efficiency is affected by the inductor dc resistance (DCR). Lower DCR improves efficiency. However, there is a trade off between DCR and inductor footprint; furthermore, shielded inductors typically have higher DCR than unshielded ones. Table 3 lists the recommended inductors.

(7)

(6)

(8)

(9)

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	$L(\mu H)$	$DCR(m\Omega)$	Isat(A)	Size $(L \times W \times H$ mm)
TOKO				
$A915AY - 4R7M$	4.7	38	1.87	$5.2 \times 5.2 \times 3.0$
A915AY - 100M	10	75	1.24	$5.2 \times 5.2 \times 3.0$
TDK				
SLF6028T - 4R7N1R6	4.7	38	1.87	$5.2 \times 5.2 \times 3.0$
SLF6028T - 4R7N1R6	10	75	1.24	$5.2 \times 5.2 \times 3.0$

Table 3. Recommended Inductor for TPS61187

OUTPUT CAPACITOR SELECTION

The output capacitor is mainly selected to meet the requirement for output ripple and loop stability. This ripple voltage is related to the capacitance of the capacitor and its equivalent series resistance (ESR). Assuming a capacitor with zero ESR, the minimum capacitance needed for a given ripple can be calculated with Equation 9:

$$
Cout = \frac{(Vout - Vin) \times Iout}{Vout \times F_S \times Vripple}
$$

Where:

Vripple = peak-to-peak output ripple. The additional part of the ripple caused by ESR is calculated using: Vripple $ESR =$ Iout x RESR

Due to its low ESR, Vripple_ESR can be neglected for ceramic capacitors, but must be considered if tantalum or electrolytic capacitors are used. The controller output voltage also ripples due to the load transient that occurs during PWM dimming. The TPS61187 adopts a patented technology to limit this type of output ripple even with the minimum recommended output capacitance. In a typical application, the output ripple is less than 250 mV during PWM dimming with a 4.7 µF output capacitor. However, the output ripple decreases with higher output capacitances.

ISOLATION FET SELECTION

The TPS61187 provides a gate driver to an external P channel MOSFET which can be turned off during device shutdown or fault condition. This MOSFET can provide a true shutdown function and also protect the battery from output short circuit conditions. The source of the PMOS should be connected to the input, and a pull-up resistor is required between the source and gate of the FET to keep the FET off during IC shutdown. To turn on the isolation FET, the FAULT pin is pulled low and clamped at 8 V below the VBAT pin voltage. During device shutdown or fault condition, the isolation FET is turned off, and the input voltage is applied on the isolation MOSFET. During a short circuit condition, the catch diode (D2 in the typical application circuit) is forward biased when the isolation FET is turned off. The drain of the isolation FET swings below ground. The voltage across the isolation FET can be momentarily greater than the input voltage. Therefore, select a 30 V PMOS for a 24 V maximum input. The on resistance of the FET has a large impact on power conversion efficiency since the FET carries the input voltage. Select a MOSFET with $R_{ds(on)}$ less than 100 mΩ to limit the power losses.

LAYOUT CONSIDERATION

As for all switching power supplies, especially those providing high current and using high switching frequencies, layout is an important design step. If layout is not carefully done, the regulator could show instability as well as EMI problems. Therefore, use wide and short traces for high current paths. The input capacitor, C1 in the Typical Application – Phase Shift PWM Mode figure, needs not only to be close to the VIN pin, but also to the GND pin in order to reduce the input ripple seen by the IC. The input capacitor, C1 in the typical application circuit, should also be placed close to the inductor. C2 is the filter and noise decoupling capacitor for the internal linear regulator powering the internal digital circuits. It should be placed as close as possible between the VDDIO and AGND pins to prevent any noise insertion to the digital circuits. The SW pin carries high current with fast rising and falling edges. Therefore, the connection between the pin to the inductor and schottky diode should be kept as short and wide as possible. It is also beneficial to have the ground of the output capacitor C3 close to the PGND pin since there is a large ground return current flowing between them. When laying out signal grounds, it is recommended to use short traces separated from power ground traces, and connect them together at a single point, for example on the thermal pad. The thermal pad needs to be soldered on to the PCB and connected to the GND pin of the IC. An additional thermal via can significantly improve power dissipation of the IC.

REVISION HISTORY

www.ti.com 10-Dec-2020

PACKAGING INFORMATION

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

TEXAS

TAPE AND REEL INFORMATION

ISTRUMENTS

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Pack Materials-Page 1

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PACKAGE MATERIALS INFORMATION

*All dimensions are nominal

GENERIC PACKAGE VIEW

RTJ 20 WQFN - 0.8 mm max height

4 x 4, 0.5 mm pitch PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

PACKAGE OUTLINE

LEADFRAME EXAMPLE 4222370

PACKAGE OUTLINE

WQFN - 0.8 mm max height RTJ0020D

PLASTIC QUAD FLATPACK - NO LEAD

NOTES: with a second contract of the s

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

RTJ0020D WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RTJ0020D WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations..

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